XP131A1617SR

Power MOSFET

■GENERAL DESCRIPTION

The XP131A1617SR is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy The small SOP-8 package makes high density mounting possible.

■ APPLICATIONS

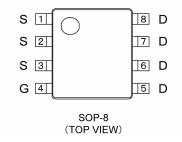
Notebook PCs

- Cellular and portable phones
- •On-board power supplies
- Li-ion battery systems

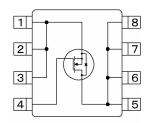
■FEATURES

Low On-State Resistance: Rds(on)=0.014 Ω (Vgs=4.5V) : Rds(on)=0.019 Ω (Vgs=2.5V) Ultra High-Speed Switching Driving Voltage : 2.5V N-Channel Power MOSFET DMOS Structure Package : SOP-8

■ PIN CONFIGURATION



■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1~3	S	Source
4	G	Gate
5~8	D	Drain

■ABSOLUTE MAXIMUM RATINGS

Та	=	25°C

ETR1105_001

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	20	V
Gate-Source Voltage	Vgss	±12	V
Drain Current (DC)	ld	10	А
Drain Current (Pulse)	ldp	40	А
Reverse Drain Current	ldr	10	А
Channel Power Dissipation *	Pd	2.5	W
Channel Temperature	Tch	150	°C
Storage Temperature Range	Tstg	-55~150	°C

* When implemented on a glass epoxy PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics Ta = 25°							
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Drain Cut-Off Current	ldss	Vds=20V, Vgs=0V	-	-	10	μA	
Gate-Source Leak Current	lgss	Vgs=±12V, Vds=0V	-	-	±1	μA	
Gate-Source Cut-Off Voltage	Vgs(off)	ld=1mA, Vds=10V	0.7	-	1.4	V	
Drain-Source On-State Resistance *	Rds(on)	ld=5A, Vgs=4.5V	-	0.010	0.014	Ω	
		ld=5A, Vgs=2.5V	-	0.013	0.019	Ω	
Forward Transfer Admittance *	Yfs	ld=5A, Vds=10V	-	32	-	S	
Body Drain Diode Forward Voltage	Vf	lf=10A, Vgs=0V	-	0.8	1.1	V	

* Effective during pulse test.

Dynamic Characteristics

Dynamic CharacteristicsTa = 25							_
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Input Capacitance	Ciss		-	1650	-	pF	
Output Capacitance	Coss	Vds=10V, Vgs=0V f=1MHz	-	1000	-	pF	
Feedback Capacitance	Crss		-	450	-	pF	

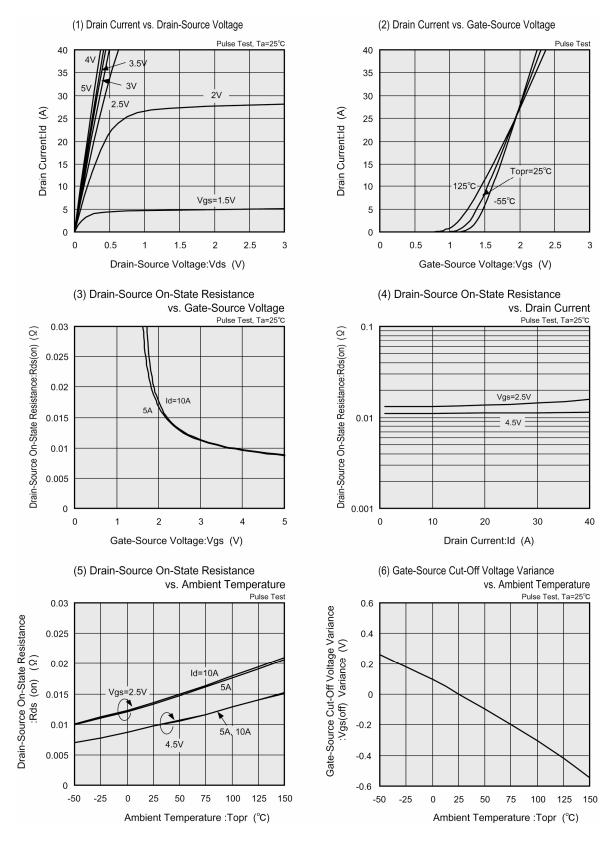
Switching Characteristics

Switching Characteristics Ta = 25°C						
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)		-	15	-	ns
Rise Time	tr	Vgs=5V, Id=5A Vdd=10V	-	25	-	ns
Turn-Off Delay Time	td (off)		-	65	-	ns
Fall Time	tf		-	15	-	ns

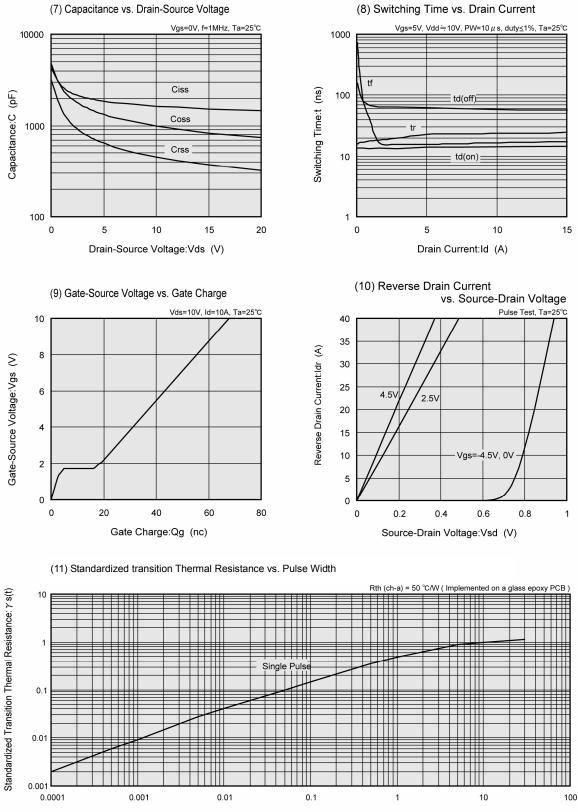
Thermal Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Aambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	50	-	°C/W

■TYPICAL PERFORMANCE CHARACTERISTICS



■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



Pulse Width:PW (s)

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